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- $1.1\,$ Scope. This drawing describes device requirements for class B microcircuits in accordance with $1.\overline{2.1}$ of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant
 - 1.2 Part number. The complete part number shall be as shown in the following example:



1.2.1 Device types. The device types shall identify the circuit function as follows:

Device type	Generic number	Circuit function
01 02	1543 1544	Power supply output supervisory circuit Power supply output supervisory circuit

1.2.2 $\underline{\text{Case outlines}}$. The case outlines shall be as designated in appendix C of MIL-M-38510, and as follows:

Outline letter Case outline

D-2(16-lead, .840" x .310" x .200"), dual-in-line package D-6(18-lead, .960" x .310" x .200"), dual-in-line package

1.3 Absolute maximum ratings.

40 V dc V_{IN} -600 mA <u>1</u>/ 40 V dc 50 mA 1000 mW 2/ 3/ -65°C to +150°C Lead temperature (soldering, 10 seconds) - - - - -+300°C Thermal resistance, junction-to-case (θ_{JC}): Cases E and V - - -See MIL-M-38510, appendix C +150°C

1.4 Recommended operating conditions.

Ambient operating temperature range (T_A) - - - - - -55°C to +125°C

- At higher input voltages, a dissipation limiting resistor (R_G) is required: $R_{G} > \frac{V_{IN} - 5 V}{0.2 A}.$
- 2/ Derate linearly above T_A = +25°C at 8.0 mW/°C. 3/ Must withstand the added P_D due to short circuit test, e.g., I_{OS} .

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2. APPLICABLE DOCUMENTS

2.1 Government specification and standard. Unless otherwise specified, the following specification and standard, of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

SPECIFICATION

MILITARY

MIL-M-38510

- Microcircuits, General Specification for

STANDARD

MILITARY

MIL-STD-883

- Test Methods and Procedures for Microelectronics

(Copies of the specification and standard required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.

3. REQUIREMENTS

- 3.1 Item requirements. The individual item requirements shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein.
- 3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.
 - 3.2.1 Terminal connections. The terminal connections shall be as specified on figure 1.
 - 3.2.2 Functional diagrams. The functional diagrams shall be as specified on figure 2.
 - 3.2.3 <u>Case outlines</u>. The case outlines shall be in accordance with 1.2.2 herein.
- 3.3 Electrical performance characteristics. Unless otherwise specified, the electrical performance characteristics are as specified in table I and apply over the full ambient operating temperature range.
- 3.4 Marking. Marking shall be in accordance with MIL-STD-883 (see 3.1 herein). The part shall be marked with the part number listed in 1.2 herein. In addition, the manufacturer's part number may also be marked as listed in 6.4 herein.
- 3.5 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in 6.4. The certificate of compliance submitted to DESC-ECS prior to listing as an approved source of supply shall state that the manufacturer's product meets the requirements of MIL-STD-883 (see 3.1 herein) and the requirements herein.
- 3.6 Certificate of conformance. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.
- 3.7 Notification of change. Notification of change to DESC-ECS shall be required in accordance with MIL-STD-883 (see 3.1 herein).

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Test	Symbol	Conditions T _J = -55°C to +125°C V _{IN} = 10 V	Device types	Group A subgroups	Li Min	mits Max	Unit
Total device		unless otherwise specifie	ia 		! !	<u> </u>	<u> </u>
Input voltage range	Į V _{INR}	Ţ	A11	1,2	4.5	1 40	V
,				-	4.7	40	-
Supply current	Is	V _{IN} = 40 V	A11	1 2,3		10	_ mA
Reference section (pi	ns V _{REF} and	i V _{IN})	 '	1 2,0	(1 10	
Output voltage	v _o		A11	1	2.48	2.52	٧
	1			2,3	2.45	12.55	Ť
Line regulation	VLINE	V _{IN} = 5.0 V to 30 V	A11	1,2,3		 5.0 	l mV
Load regulation	VLOAD	I _{REF} = 0 mA to 10 mA	A11	1,2,3		10	T
Short circuit current	Ios	V _{REF} = 0 V	A11	1,2,3	-12	 - 40	l mA
SCR TRIGGER section (pins SCR TF	RIGGER, REMOTE ACTIVATE, ar	d RESET)			The second second	
Peak output current	^I O(pk)	$V_{IN} = 5.0 \text{ V}, R_{G} = 0\Omega,$ $V_{O} = 0 \text{ V}$	A11	1,2,3	- 100	 -600 	mA
Peak output voltage	V ₀ (pk)	VIN = 15 V, IO = 100 mA	A11	1,2,3	12		٧
Output off voltage	V _{O(off)}	V _{IN} = 40 V	All	1,2,3		0.1	Ť
See footnotes at end of		SIZE					
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TABLE	I. Elect	rical	performanc	e charact	eristics -	Continued.			
Test	 Symbol 	TJ	Conditi = -55°C t V _{IN} =	o +125°C	 Device types	 Group A subgroups		mits Max	Unit
	<u> </u> 	unles	s otherwis		ed	<u> </u>			<u> </u>
SCR TRIGGER section (p	ins SCR TR	IGGER,	REMOTE AC	TIVATE, a	nd RESET) -	continued			
REMOTE ACTIVATE current	I I ACT	 Pin RI 	EMOTE ACTI	VATE = GN	D A11	1,2,3	 	-0.8	mA
REMOTE ACTIVATE voltage	I I V _{ACT}	 Pin RI	EMOTE ACTI	VATE open	A11	1,2,3	 	6.0	V
RESET current	I I RESET		REMOTE ACT	IVATE and	A11	1,2,3	[-0.8 	mA
RESET voltage	VRESET	 Pin Ri Pin Ri	ESET = ope EMOTE ACTI	n, VÁTE = GN	A11	1,2,3		6.0	V
Comparator sections (pins OV INDICATE, OV DELAY, OV INPUT, UV INPUT, UV DELAY, and UV INDICATE, For device O2, OV and UV INPUTS are tested inverted and noninverted) Input threshold voltage VIN(th) All 1 2.45 2.55 V									
1/	IN(CII) 	[[2,3	2.40	2.60	
Input bias current	I I I B	Sense	input = 0	٧	A11	1,2,3	 	1-1.0	μA
Delay saturation voltage	V _D (SAT)	i 			A11	1,2,3		0.5	V
Delay high level voltage	v _{DH}				A11	1,2,3		8.0	<u> </u>
Delay charging current	I _D	V _D = 0) V		A11	1,2,3	-200	-300	μA
Indicate saturation	VIND(SAT)	 I _L = 4	+10 mA		A11	1,2,3	1	0.5	٧
Indicate leakage current	I _L (IND)	VIND =	= 40 V		A11	1,2,3		1.0	μ Α
See footnotes at end of	table.					:			
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TABLI	E I. Elect	rical performance characteri	stics -	Continued.			
Test	Symbo1			 Group A subgroups	Li	 Unit	
		$V_{IN} = 10 \text{ V}$ unless otherwise specified	 	Subgroups	Min	Max	
Current limit section	(pins CL I	NV INPUT, CL NI INPUT, OFFSE	T/COMP,	CL OUTPUT,	GROUN	D)	
Input voltage range	VINR		I ATT	1,2,3	0	V _{IN} -	V
Input bias current	IIB	Pin OFFSET/COMP = open,	 A11 	1,2,3		-1.0 	μ A
Input offset voltage	v _{os}	Pin OFFSET/COMP = open,	All	1,2,3		10	l mV
		10 k Ω ±0.1% from OFFSET/ COMP pin to GROUND. 2 k Ω from C $_L$ OUTPUT to V_{REF}	A11 A11	1,2,3	80	120	1 - - - -
Common mode rejection	CMRR	0 V < V _{CM} < 12 V,	A11	4,5,6	60	 	l dB
Open loop voltage gain	A VOL	Pin OFFSET/COMP = open, V _{CM} = 0 V	A11 	4,5,6	72		T
Output saturation	V _O (SAT)	I _L = -10 mA	A11	1,2,3		0.5	V
Output leakage	IL(IND)	V _{IND} = 40 V	A11	1,2,3		1.0	μА

 $[\]underline{1}/$ Input voltage rising on pin OV input and falling on pin UV input.

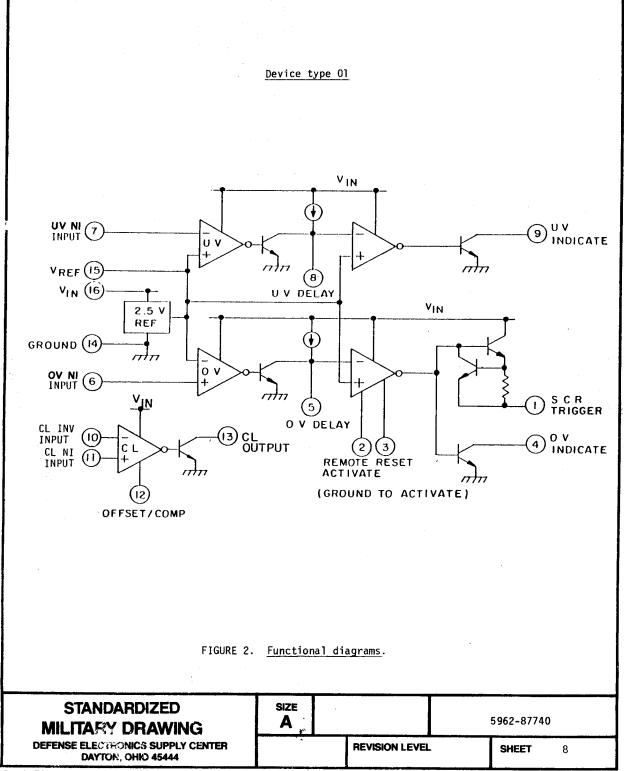
- 3.8 <u>Verification and review</u>. DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.
 - 4. QUALITY ASSURANCE PROVISIONS
- 4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein).

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Device type 01 Case E SCR TRIGGER [€ VIN REMOTE ACTIVATE 5 V_{REF} RESET 4 GROUND O V INDICATE I CL OUTPUT O V DELAY 2 OFFSET/COMP OV NI INPUT 6 II CL NI INPUT UV NI INPUT O CL INV INPUT UV DELAY 8 9 UV INDICATE Device type 02 Case V SCR TRIGGER B VIN REMOTE ACTIVATE 7 V_{REF} RESET 3 6 GROUND O V INDICATE 5 CLOUTPUT O V DELAY 4 OFFSET/COMP OVNI INPUT 3 CLNI INPUT OV INV INPUT 7 2 CLINVINPUT **UV NI INPUT** 8 UV INDICATE 9 **UV INV INPUT** U V DELAY

FIGURE 1. Terminal connections (top view).

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Device type 02

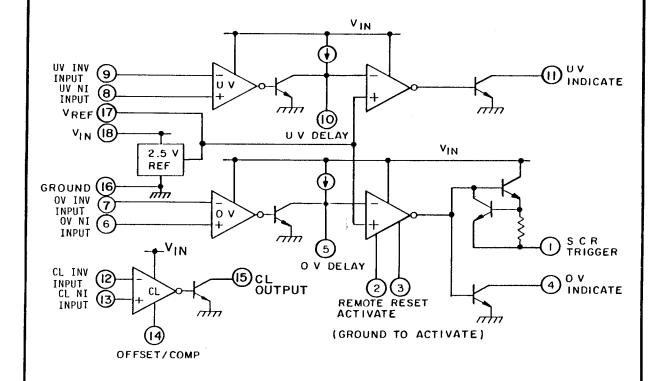


FIGURE 2. Functional diagrams - Continued.

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- 4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:
 - a. Burn-in test, method 1015 of MIL-STD-883.
 - (1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.5 herein).
 - (2) $T_A = +125^{\circ}C$, minimum.
 - b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.
- 4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.
 - 4.3.1 Group A inspection.
 - a. Tests shall be as specified in table II herein.
 - b. Subgroups 7, 8, 9, 10, and 11 in table I, method 5005 of MIL-STD-883 shall be omitted.
 - 4.3.2 Groups C and D inspections.
 - a. End-point electrical parameters shall be as specified in table II herein.
 - b. Steady-state life test conditions, method 1005 of MIL-STD-883:
 - (1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.5 herein).
 - (2) $T_A = +125^{\circ}C$, minimum.
 - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (per method 5005, table I)
Interim electrical parameters (method 5004)	1
Final electrical test parameters (method 5004)	1*,2,3,4
Group A test requirements (method 5005)	1,2,3,4,5,6
Groups C and D end-point electrical parameters (method 5005)	1,2,3

* PDA applies to subgroup 1.

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- 5. PACKAGING
- 5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-M-38510.
 - 6. NOTES
- 6.1 Intended use. Microcircuits conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for OEM application. When a military specification exists and the product covered by this drawing has been qualified for listing on QPL-38510, the device specified herein will be inactivated and will not be used for new design. The QPL-38510 product shall be the preferred item for all applications.
- 6.2 <u>Replaceability</u>. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
- 6.3 Comments. Comments on this drawing should be directed to DESC-ECS, Dayton, Ohio 45444, or telephone $\overline{513-296}-5375$.
- 6.4 <u>Approved sources of supply</u>. Approved sources of supply are listed herein. Additional sources will be added as they become available. The vendors listed herein have agreed to this drawing and a certificate of compliance (see 3.5 herein) has been submitted to DESC-ECS.

	Military drawing part number	Vendor CAGE number	Vendor similar part number <u>1</u> /
032 311	5962-8774001EX	34333 48726	SG1543J/883B UC1543J/883B
039171	5962-8774002VX [34333 48726	SG1544J/883B UC1544J/883B

1/ Caution. Do not use this number for item acquisition. Items acquired by this number may not satisfy the performance requirements of this drawing.

Vendor CAGE number	Vendor name and address
34333	Silicon General, Inc. 11651 Monarch St. Garden Grove, CA 92641
48726	Unitrode Corp. 7 Continental Blvd. Merrimack, NH 03054

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